

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of :
Morio GAKU et al. :
Serial No. NEW : Attn: APPLICATION BRANCH
Filed March 2, 2004 : Attorney Docket No. 2004_0313

SEMICONDUCTOR PLASTIC PACKAGE AND
PROCESS FOR THE PRODUCTION THEREOF
(Rule 1.53(b) Divisional
of Serial No. 10/036,385,
Filed January 7, 2002)

CLAIM OF PRIORITY UNDER 35 USC 119

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

THE COMMISSIONER IS AUTHORIZED
TO CHARGE ANY DEFICIENCY IN THE
FEES FOR THIS PAPER TO DEPOSIT
ACCOUNT NO. 23-0975

Sir:

Applicants in the above-entitled application hereby claim the dates of priority under the International Convention of Japanese Patent Application No. 340129/97, filed December 10, 1997, Japanese Patent Application No. 4836/98, filed January 13, 1998, Japanese Patent Application No. 11528/98, filed January 23, 1998, Japanese Patent Application No. 34234/98, filed January 30, 1998, Japanese Patent Application No. 34235/98, filed January 30, 1998, Japanese Patent Application No. 34236/98, filed January 30, 1998, Japanese Patent Application No. 15893/98, filed January 28, 1998, Japanese Patent Application No. 17045/98, filed January 29, 1998, Japanese Patent Application No. 34238/98, filed January 30, 1998, Japanese Patent Application No. 38917/98, filed February 20, 1998, Japanese Patent Application No. 3984/98, January 12, 1998, Japanese Patent Application No. 975/98, filed January 6, 1998, Japanese Patent Application No. 4835/98, filed January 13, 1998, Japanese Patent Application No. 9567/98, filed January 21, 1998, Japanese Patent Application No. 9568/98, filed January 21, 1998, Japanese Patent Application No. 34232/98, filed January 30, 1998, and Japanese Patent Application No. 34233/98, filed January 30, 1998, as acknowledged in the Declaration of this application.